



### Current trends in industrial electronics education

#### Theme:

Keeping abreast with the rapid evolution in contemporary industrial electronics engineering calls for new educational technologies, tools, platforms, and methodologies.

The aim of this special issue is to collect and disseminate articles that present original approaches and successful case studies for state-of-the-art education within IES areas of interest. Applications of current technologies or new educational paradigms are especially welcome.

Topics of interest of this Special Section include, but are not limited to:

- e-Learning platform functions and facilities
- Distance learning: methods, technologies and assessment.
- Lifelong learning.
- Capstone and senior design experiences.
- Successful remote laboratory case studies.
- Simulation / emulation based educational platforms.
- Virtual instrumentation.
- Reconfigurable educational platforms.

#### Manuscript Preparation and Submission

Please follow the guidelines in “Information for Authors” section of the IEEE Transaction on Industrial Electronics <http://tie.ieee-ies.org/tie/>

Please submit your manuscript in electronic form through Manuscript Central web site: <http://mc.manuscriptcentral.com/tie-ieee>. On the submitting page #1 in popup menu of manuscript type, select: SS Education

#### Timetable

<b>Deadline for manuscript submissions</b>	<b>December 31, 2008</b>
<b>Information about manuscript acceptance</b>	<b>February 28, 2009</b>
<b>Estimated publication date</b>	<b>2009</b>

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